

Global Display Driver IC Chip-on-Film (COF) Package Modules Supply, Demand and Key Producers, 2026-2032

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Abstracts

The global Display Driver IC Chip-on-Film (COF) Package Modules market size is expected to reach \$ 1054 million by 2032, rising at a market growth of 5.2% CAGR during the forecast period (2026-2032).

Display driver IC chip on film package modules are physical semiconductor packaging components used for driver connection in display panels. The core process is to mount display driver IC chips onto flexible film circuit substrates and complete gold bump connection, inner lead bonding, outer lead connection, encapsulation protection and electrical testing, enabling high density, low impedance and stable transmission of display driver signals between the display panel, the driver IC and the main control circuit. The product mainly covers source driver COF modules, gate driver COF modules, two metal COF modules, fine pitch COF modules, thermally enhanced COF modules and large size display COF modules. Key processes include roll to roll flexible circuit fabrication, wafer gold bumping, chip mounting, thermal compression bonding, encapsulation resin protection, visual inspection and final electrical testing. Key specifications usually include line pitch, lead pitch, film width, copper layer structure, bending reliability, thermal resistance, electrical yield, bonding strength and panel side connection stability. Major applications include LCD televisions, monitors, notebook computers, tablets, automotive displays, OLED displays and high resolution large size display modules. Based on the finished COF package module product scope, the global average industry price of display driver IC COF package modules in 2025 was about USD 0.45 to USD 0.85 per unit, the average industry gross margin was about 24% to 32%, and global shipment volume was about 0.9 to 1.6 billion units.

Display driver IC COF package modules sit in the middle of the display panel value

chain. The upstream side includes PI film, copper foil, photo patterning materials, encapsulation resin, gold bumping materials, COF tape substrates and display driver IC wafers. The midstream stage covers COF circuit fabrication, chip mounting, thermal compression bonding, encapsulation protection and final testing. The downstream side serves televisions, monitors, notebook computers, tablets, automotive displays, OLED display modules and other high resolution display products. This product is not a general flexible printed circuit and it is not simply a display driver IC. It is a driver packaging and connection format that enables high density routing, narrow bezel design, stable signal transmission and reliable panel assembly. Demand remains supported by large size high resolution displays, automotive multi display systems and the continued migration of display modules toward thinner and more integrated designs. However, growth is more likely to come from specification upgrades and application mix changes than from a broad surge in end device shipments.

The competitive structure is highly concentrated by region and by process capability. Core supply is mainly built around Taiwan, mainland China and South Korea, while Japan and other regions play a stronger role in materials, flexible substrates and selected upstream processes. The real barrier is not just packaging capacity. It is the combined capability in gold bumping, fine pitch flexible circuits, high precision chip placement, bonding reliability, yield control, panel customer qualification and stable high volume delivery. Some companies focus on display driver IC back end packaging and testing, while others specialize in COF tape substrates and flexible circuit structures. These two groups are closely linked, but they should not be counted under the same revenue boundary without adjustment. Mainland Chinese suppliers have increased investment in display driver packaging, COF tape production and integrated COF IC manufacturing, which is gradually reshaping the supply chain from an externally dependent structure toward a more localized and regionally diversified model.

The policy and capital environment remains supportive because display panels, advanced packaging, semiconductor localization and automotive electronics are all strategic manufacturing priorities in major markets. Investment is moving toward finer pitch COF lines, two metal COF structures, better thermal designs, higher automation in testing and more stable mass production for large size and automotive display applications. The outlook is stable rather than aggressively high growth. COG, COP, panel level integration and new display architectures will continue to take part of the demand in small size and high end devices, but COF still has a clear role where mature processing, cost efficiency, bending tolerance and mass production reliability matter. The industry's future opportunities will come from higher specification products, a more complete local supply chain, stronger automotive and industrial display adoption, and

better process integration between COF substrates, driver IC packaging and panel module assembly.

This report studies the global Display Driver IC Chip-on-Film (COF) Package Modules production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Display Driver IC Chip-on-Film (COF) Package Modules and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of Display Driver IC Chip-on-Film (COF) Package Modules that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global Display Driver IC Chip-on-Film (COF) Package Modules total production and demand, 2021-2032, (Million Units)

Global Display Driver IC Chip-on-Film (COF) Package Modules total production value, 2021-2032, (USD Million)

Global Display Driver IC Chip-on-Film (COF) Package Modules production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (Million Units), (based on production site)

Global Display Driver IC Chip-on-Film (COF) Package Modules consumption by region & country, CAGR, 2021-2032 & (Million Units)

U.S. VS China: Display Driver IC Chip-on-Film (COF) Package Modules domestic production, consumption, key domestic manufacturers and share

Global Display Driver IC Chip-on-Film (COF) Package Modules production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (Million Units)

Global Display Driver IC Chip-on-Film (COF) Package Modules production by Type, production, value, CAGR, 2021-2032, (USD Million) & (Million Units)

Global Display Driver IC Chip-on-Film (COF) Package Modules production by Application, production, value, CAGR, 2021-2032, (USD Million) & (Million Units)

This report profiles key players in the global Display Driver IC Chip-on-Film (COF) Package Modules market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Chipbond Technology Corporation, ChipMOS TECHNOLOGIES INC., Hefei Chipmore

Technology Co., Ltd., Union Semiconductor (Hefei) Co., Ltd., LB Semicon Inc., Changzhou Xingsheng Semiconductor Technology Co., Ltd., LG Innotek Co., Ltd., STEMCO Co., Ltd., JMC Electronics Co., Ltd., FLEXCEED Co., Ltd., etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Display Driver IC Chip-on-Film (COF) Package Modules market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Million Units) and average price (US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global Display Driver IC Chip-on-Film (COF) Package Modules Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Global Display Driver IC Chip-on-Film (COF) Package Modules Market, Segmentation

Global Display Driver IC Chip-on-Film (COF) Package Modules Supply, Demand and Key Producers, 2026-2032

by Type:

Source Driver COF Modules

Gate Driver COF Modules

Combined Driver COF Modules

Others

Global Display Driver IC Chip-on-Film (COF) Package Modules Market, Segmentation
by Circuit Metal Structure:

One Metal COF Modules

Two Metal COF Modules

Others

Global Display Driver IC Chip-on-Film (COF) Package Modules Market, Segmentation
by Lead Pitch:

Standard Pitch COF Modules (>30 ?m)

Fine Pitch COF Modules (15?30 ?m)

Super Fine Pitch COF Modules (

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